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DESCRIPTION

OFFSET ROTOR FLAT MEDIA PROCESSOR

Technical Field

5 The technical field of this invention is centrifugal processing equipment and methods used to process semiconductor wafers, photomasks, optical and glass disks, magnetic disks, flat panels, lenses or similar flat media.

BACKGROUND OF THE INVENTION

10 The production of semiconductor wafers, substrates and photomask plates used in the manufacture of semiconductor wafers, has typically utilized processing equipment in which various types of processing fluids are used to treat the wafers. One example of a semiconductor processor is a centrifugal rinser-dryer used to rinse acids, caustics, etchants and other processing fluids from wafers, photomask plates, and similar flat media.

15 The rinser-dryers are also used to dry the rinsed units using a flow of heated gas, such as nitrogen, which is passed through the processing chamber after rinsing with the desired fluid. The wafers are spun during processing to provide more even distribution of the processing fluids across the wafer surfaces, and to assist in removal of rinsing liquids in preparation for drying.

20 Other types of semiconductor processors include acid, solvent, and caustic treatment machines which spray or otherwise apply acids, solvents and caustics to the wafers or other flat media. Stripping processors are used to remove photoresist from the wafers. Other specific processing of semiconductors may require other types of chemicals. Many of these processes are performed in centrifugal processing machines to provide for
25 even distribution of fluids over the wafer and to aid in removal of liquids.

A primary problem in the production of semiconductors is particle contamination. Contaminant particles can affect the photographic processes used to transfer the chip

layouts onto the wafers being processed into chips. Contaminants on the photomasks can cause deterioration of the image being transferred onto the wafer. The direct processing of the wafers themselves is even more susceptible to contamination because of the numerous processing steps involved and the risk at each stage that contaminating particles can become adhered to the surface of the wafer. Particle contamination causes a large number of the chips in a wafer to be defective. Thus it is very important to reduce contamination to increase yields.

With the high resolution now made possible through newer semiconductor processing techniques, the effects of contaminants have become even more significant and problematic than in the past. Previously, contaminant particles smaller than 1 micron did not result in defects due to minimum feature sizes of 2 microns or more. However, now the feature size used in high density chip designs is substantially less, e.g., 0.18 micron. Even higher density chips with even smaller feature sizes are expected in the future. The move toward smaller feature size is compounding the contamination problem because of the greater difficulty in controlling smaller particles in the environment. If contaminants are present then substantial numbers of the resulting chips can be rendered defective and unusable, at substantial costs to the manufacturer.

The causes of contaminating particles on wafer surfaces occurs from numerous sources. Each of the processing fluids used is necessarily impure to some small degree. The water used in processing is deionized to remove metallic ions and other impurities, but such supplies also contain some impurities. Centrifugal processing is advantageous because spinning the wafers or other flat media flings off fluid droplets. This helps to prevent contamination by "spotting" which occurs if fluid droplets on the wafer evaporate. It is also advantageous to have the used rinse water or fluids removed from the processing chamber as quickly as possible, to prevent recontamination.

Centrifugal processors, such as spray solvent and spray acid processors, and spin rinser dryers, typically have a rotor which spins inside of a cylindrical processing chamber or bowl. The cylindrical rotor holds a removable cassette or non-removable combs which carry the wafers. The bowl typically has a drainage ditch or channel running from the front to the rear, near the bottom of the bowl, to drain fluids out of the bowl. These types

of centrifugal processors have been used very successfully in semiconductor manufacturing.

However, in these types of centrifugal processors, the spinning rotor, which is centered in the bowl, generates rapid counter-clockwise air movement within the bowl.
5 This air movement hinders the clean drying or other processing operation of the centrifugal processor, as it tends to draw spent fluid droplets of e.g., water, solvent, or acid, up and around in the bowl, allowing droplets to be re-deposited on the wafers or other flat media. The air movement also tends to draw droplets away from the drainage channel, allowing them to be disadvantageously recycled back up and around the bowl.

10 Accordingly, there remains a need in semiconductor manufacturing for improved centrifugal processing machines.

STATEMENT OF THE INVENTION

The present invention is directed to a centrifugal processor with a rotor contained
15 within a bowl or chamber which is designed to better direct and scavenge fluids from the bowl. By doing so, a more complete process can be accomplished with less risk of contamination from spent fluid.

In a first separate aspect of the present invention, the centrifugal processor includes a rotor offset from the centerline of the bowl. The offset provides an area of lower fluid
20 velocities. Thus, separation of entrained fluid droplets from the rotating air or gas flow is enhanced.

In a second separate aspect of the present invention, the centrifugal processor includes drain openings in the form of staggered slots. The slots quickly remove spent fluid from the bowl and inhibit any re-entraining of the fluid into the air flow within the
25 bowl.

In a third separate aspect of the present invention, the slots of the second separate aspect include peripheries which are not perpendicular to the flow. With such a configuration, fluid droplets accumulate and more readily fall out of the bowl.

In a fourth separate aspect of the present invention, any one or more of the foregoing separate aspects are contemplated to be combined to enhance removal of fluid droplets.

Accordingly, an object of the present invention is to provide an improved
5 centrifugal processor, which more effectively removes used fluid from the bowl, thereby reducing the potential for recontamination of the silicon wafers or other flat media.

BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a perspective view of the centrifugal processor of the invention;

10 Fig. 2 is a perspective view of a bowl of a prior art machine;

Fig. 3. is a perspective view of the bowl of the present centrifugal processor shown in Fig. 1;

Fig. 4 is a front elevation view of the bowl and rotor of the centrifugal processor shown in Fig. 1;

15 Fig. 5 is a section view taken along line 5-5 of Fig. 4;

Fig. 6 is a perspective view of a bowl according to a second embodiment of the invention;

Fig. 7 is a section view taken along line 7-7 of Fig. 6;

Fig. 8 is an enlarged detail of the openings shown in Figs. 6 and 7;

20 Fig. 9 is a perspective view of a comb rotor having combs for directly holding wafers or other flat media; and

Fig. 10 is a perspective view of a cassette holding wafers, with the cassette placeable into the rotor shown in Figs. 3 and 6.

DETAILED DESCRIPTION OF THE DRAWINGS

Turning now in detail to the drawings, as shown in Fig. 1, the present centrifugal processor **10** has a cylindrical bowl **14** mounted within a housing **12**. Referring to Figs. 1, 4 and 5, a cylindrical cassette rotor **18** is rotatably mounted within the bowl **14**. The back end of the rotor **18** is connected to a drive motor **16**, which spins the rotor within the bowl **14**.
5 The workpieces **22** are held within the rotor **18**, in a wafer cassette **24**, as shown in Fig. 10, placed within the rotor **18**. Alternatively, a comb rotor **17**, having combs **19** for directly holding the wafers **22**, as shown in Fig. 9, may be used. The techniques for holding wafers in the combs, or for holding the wafer cassette, in a rotor, as shown in Figs. 9 and 10, are well
10 known in the art. The workpieces **22** may be semiconductor wafers, metal or glass disks, flat panels, lenses, or other flat media.

One or more fluid spray manifolds, such as manifolds **20** and **26** are positioned near the top of the bowl **14**. The wafers **22** or cassette **24** are loaded into the rotor **18** via a swing out door **30**. The manifolds may spray out liquid such as water, solvents, or acids, or gases,
15 such as nitrogen. Depending on the type of centrifugal processing performed, an ionizer **28** may also be provided.

Referring to Figs. 4 and 5, wherein the illustrated features are drawn to scale, the rotor horizontal centerline or spin axis **52** is offset above and to one side of the bowl centerline **50**. As shown in Fig. 4, the rotor spin axis is diagonally displaced from the bowl centerline **50**, by
20 a distance D , and at an angle α from vertical.

In an embodiment having a bowl inside diameter of about 35 cm, D is preferably about 1.3 cm and α is about 45° . Correspondingly, the distance E between the vertical centerline **56** of the rotor, and the vertical centerline **54** of the bowl **14** is about 0.9 cm.

Referring to Fig. 3, drain openings **41** are provided in a cluster **40** near the bottom of
25 the bowl **14**. The openings **41** pass through the cylindrical sidewall of the bowl **14**. The openings **41** are arranged in a first row **42** staggered or offset from a second row **44**. The rotor **18** spins counter-clockwise in Figs. 1, 3 and 4. The cluster **40** of drain openings **41** is located at or between the 5 o'clock (30° counter-clockwise up from bottom center) and 6 o'clock (bottom center) positions.

In use, the motor **16** spins the rotor **18**. As shown in Fig. 4, the rotor **16** is offset in a direction away from the openings **41**. This offset position helps to avoid low pressure over the openings **41**, which reduces the tendency of the spinning rotor to draw fluid droplets up and away from the openings **41**. In addition, since the drainage route out of the bowl **14** is made up of individual openings **41**, in contrast to the continuous drain channel used in prior designs, spent fluid drains more quickly from the bowl **14**. The combination of the offset rotor and openings **41** also allows spent fluid droplets which fall to the bottom of the bowl to exit the bowl under gravity via the openings, rather than splashing back onto and contaminating the wafers or workpieces. A drainage channel under the openings **41**, similar to the channel shown in Fig. 2, catches the droplets and carries them to a drain.

Figs. 6 and 8 show an alternative embodiment having a bowl **60** including alternating pairs of aligned drainage holes **62**. The drainage holes are elliptical or oval-shaped. The major axis of each hole extends at an angle of about 30° to the major axes of the adjacent holes in the adjacent row. As the spinning rotor **18** generates air movement in the direction A shown in Fig. 6, fluid droplets clinging to an edge of an opening **62** move toward the down wind (right side in Fig. 6) of the openings **62**, and collect at the down wind radius of the hole. As the droplets collect at the radius, and the volume of fluid builds up, the force of gravity surpasses the surface tension adhesion forces and aerodynamic forces. The droplet then falls through the opening, to a collection pipe or channel on the outside of the bowl **14**.

As shown in Figs. 7 and 8, in a preferred embodiment having a bowl depth R of about 280mm, three rows of openings **62** are provided, with each row having 5 openings. In the embodiment shown, the angles and dimensions S; T; U; V; W; and X are 15°; 29; 44; 22; and 57mm respectively, with the other dimensions shown proportionally to scale.

We claim:

1. A centrifugal processor comprising:
 - a housing;
 - a bowl within the housing; and
 - 5 a rotor within the bowl and rotatable about a spin axis offset from a centerline of the bowl.

2. The centrifugal processor of claim 1 wherein the rotor is offset vertically and to a first side of the bowl.

- 10 3. The centrifugal processor of claim 1 further comprising a plurality of drain openings in the bowl.

4. The centrifugal processor of claim 3 wherein the drain openings are located at
15 or between the bottom of the bowl and a position 45° counterclockwise up from the bottom of the bowl.

5. A centrifugal processor comprising:
 - a housing;
 - 20 a cylindrical bowl fixed in place within the housing;
 - a rotor rotatably and eccentrically mounted within the bowl;
 - a motor linked to the rotor; and
 - drain slots passing through the bowl.

- 25 6. A machine for processing flat media comprising:

a cylindrical bowl defining a bowl vertical center axis; and

a rotor mounted in the cylindrical bowl and rotatable in a first direction about a rotor axis, with the rotor axis offset from the bowl center axis.

5 7. The machine of claim 6 further comprising a cluster of drain openings passing through the bowl, with the cluster and the rotor axis on opposite sides of the bowl center axis.

8. The machine of claim 6 wherein the rotor axis is above the bowl center axis.

10 9. The machine of claim 6 wherein the rotor axis is positioned horizontally to one side of the bowl axis.

10. The machine of claim 7 wherein the cluster of openings is positioned in the first direction to one side of the bowl vertical center axis.

15

11. The machine of claim 6 wherein the rotor axis is located at an angle of about 45° from the bowl vertical center axis.

12. The machine of claim 6 wherein the rotor axis is spaced apart from the bowl center by about 0.5 inches.

20

13. The machine of claim 6 further comprising oblong drain openings passing through the bowl, the drain openings each defining a major axis, with the major axis of substantially each drain opening oriented at an angle to the major axis of each adjacent drain opening.

14. A centrifugal processor, comprising:
- a housing;
 - a bowl in the housing;
 - 5 a rotor within the bowl; and
 - a plurality of drain holes in the bowl.
15. The centrifugal processor of claim 1 comprising a spin rinser dryer, a spray acid processor, or a spray solvent processor.
- 10
16. The centrifugal processor of claim 14 further comprising a flat media holder within the rotor.
17. The centrifugal processor of claim 14 further comprising a flat media
15 workpiece in the holder, with the workpiece selected from the group consisting of: silicon or other semiconductor material wafers, metal or glass disks, flat panels, replacement lenses used in cataract surgery, photomasks, optical disks, and magnetic disks.
18. The centrifugal processor of claim 16 wherein the flat media holder comprises
20 a cassette within a cassette holder within the rotor.
19. The centrifugal processor of claim 16 wherein the flat media holder comprises combs attached to the rotor.

20. The centrifugal processor of claim 14 and wherein the drain holes are oblong, having a major axis and a minor axis and further comprising a motor for spinning the rotor in a first direction, with the major axis of each oblong hole positioned so that it is not parallel and not perpendicular to the first direction.

AMENDED CLAIMS

[received by the International Bureau on 01 November 1999 (01.11.99);
original claims 1 – 20 replaced by new claims 1 – 28 (5 pages)]

1. A centrifugal processor comprising:
a housing;
a bowl within the housing; and
a rotor within the bowl and rotatable about a spin axis linearly offset from a centerline of the bowl.
2. The centrifugal processor of claim 1 wherein the rotor is linearly offset vertically and to a first side of the bowl.
3. The centrifugal processor of claim 1 further comprising a plurality of drain openings in the bowl.
4. The centrifugal processor of claim 3 further comprising a motor for spinning the rotor in counterclockwise direction, wherein the drain openings are located at or between the bottom of the bowl and a position 45° counterclockwise up from the bottom of the bowl.
5. A centrifugal processor comprising:
a housing;
a cylindrical bowl fixed in place within the housing, the cylindrical bowl having a central bowl axis;
a rotor rotatably mounted within the bowl and rotatable therein about an axis offset from the central bowl axis;
a motor linked to the rotor; and
drain slots passing through the bowl.
6. A machine for processing flat media comprising:
a cylindrical bowl defining a bowl vertical center axis; and

a rotor mounted in the cylindrical bowl and rotatable therein about a rotor axis, with the rotor axis offset from and not intersecting with, the bowl center axis.

7. The machine of claim 6 further comprising a cluster of drain openings passing through the bowl, with the cluster and the rotor axis on opposite sides of the bowl center axis.

8. The machine of claim 6 wherein the rotor axis is above the bowl center axis.

9. The machine of claim 6 wherein the rotor axis is offset horizontally to one side of the bowl axis.

10. The machine of claim 7 wherein the cluster of openings is positioned in the first direction to one side of the bowl vertical center axis.

11. The machine of claim 6 wherein the rotor axis is spaced apart from the bowl center by about 0.5 inches.

12. The machine of claim 6 further comprising oblong drain openings passing through the bowl, the drain openings each defining a major axis, with the major axis of substantially each drain opening oriented at an angle to the major axis of each adjacent drain opening.

13. A centrifugal processor, comprising:
 - a housing;
 - a bowl in the housing;
 - a rotor within the bowl; and
 - a plurality of drain holes in the bowl.

14. The centrifugal processor of claim 1 comprising a manifold for spraying out water, solvents, acids, or gases.

15. The centrifugal processor of claim 13 further comprising a flat media holder within the rotor.

16. The centrifugal processor of claim 13 further comprising a flat media workpiece in the holder, with the workpiece selected from the group consisting of: silicon or other semiconductor material wafers, metal or glass disks, flat panels, replacement lenses used in cataract surgery, photomasks, optical disks, and magnetic disks.

17. The centrifugal processor of claim 15 wherein the flat media holder comprises a cassette within a cassette holder within the rotor.

18. The centrifugal processor of claim 15 wherein the flat media holder comprises combs attached to the rotor.

19. The centrifugal processor of claim 13 and wherein the drain holes are oblong, having a major axis and a minor axis and further comprising a motor for spinning the rotor in a first direction, with the major axis of each oblong hole positioned so that it is not parallel and not perpendicular to the first direction.

20. A centrifugal processor, comprising:
 - a cylindrical bowl having a centerline;

a rotor within the bowl and rotatable within the bowl about a spin axis displaced from, and not intersecting with, the centerline.

21. The centrifugal processor of claim 20 wherein the centerline and the spin axis are parallel.

22. The centrifugal processor of claim 20 wherein the rotor is cylindrical, and has a rotor centerline parallel to, but not co-linear with, the bowl centerline.

23. The centrifugal processor of claim 22 wherein the bowl centerline is inclined upwardly at an angle of from 0-30°.

24. A centrifugal processor, comprising:
a cylindrical bowl having a central bowl axis;
a rotor having a central rotor axis, with the rotor mounted within the bowl and rotatable within the bowl about the central rotor axis;
and with the central rotor axis positioned above the central bowl axis.

25. The centrifugal processor of claim 24 wherein the central rotor axis and the central bowl axis are parallel.

26. The centrifugal processor of claim 24 wherein the central rotor axis is oriented at an angle of from 0-30 degrees above horizontal.

27. A centrifugal processor, comprising:
a bowl having a central bowl axis;
a rotor having a central rotor axis with the rotor positioned within the bowl and rotatable therein about the central rotor axis;
and with the central bowl axis and the central rotor axis oriented at an angle of 0-30 degrees above horizontal.

28. The processor of claim 27 wherein the central rotor axis and the central bowl axis are parallel.

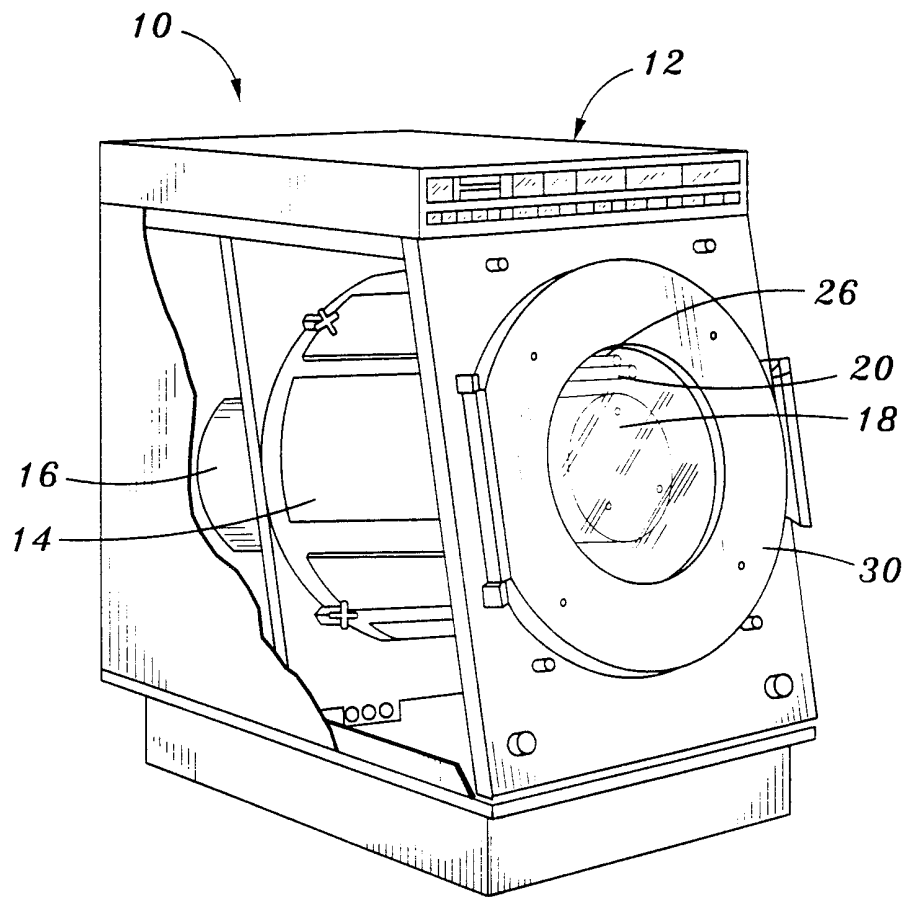


Fig. 1

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Fig. 2
(PRIOR ART)

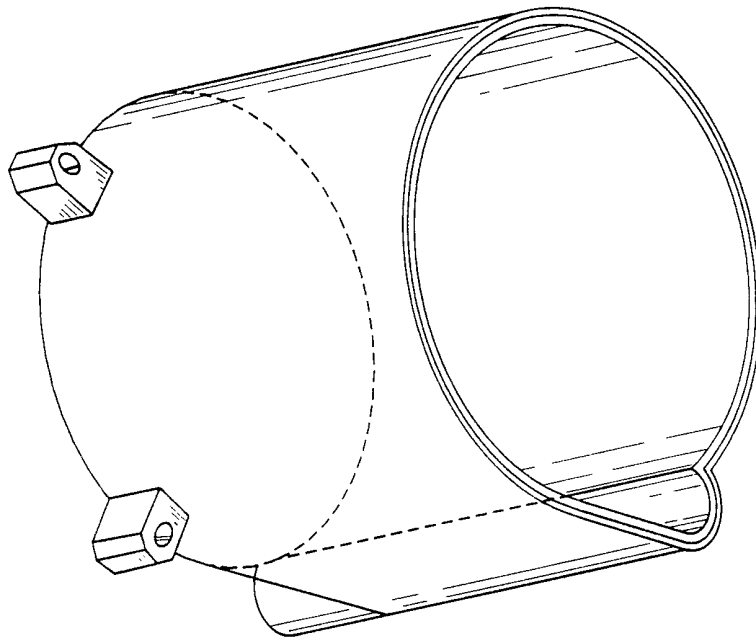


Fig. 3

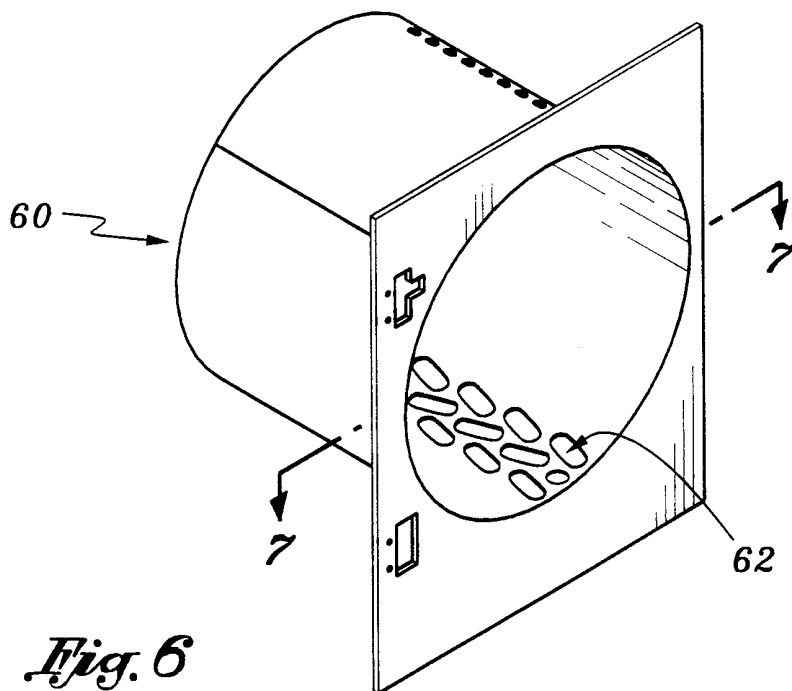
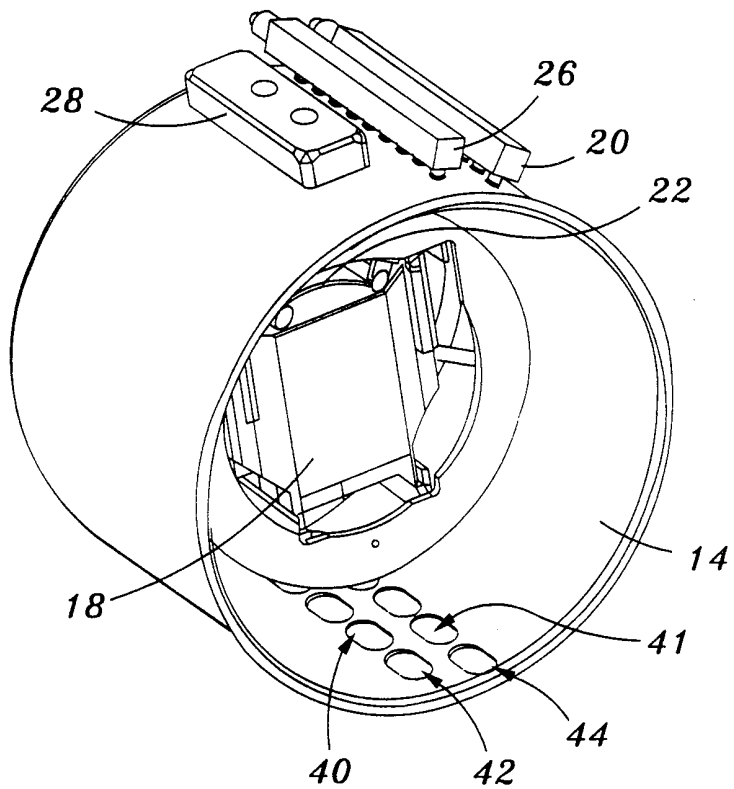


Fig. 6

Fig. 5

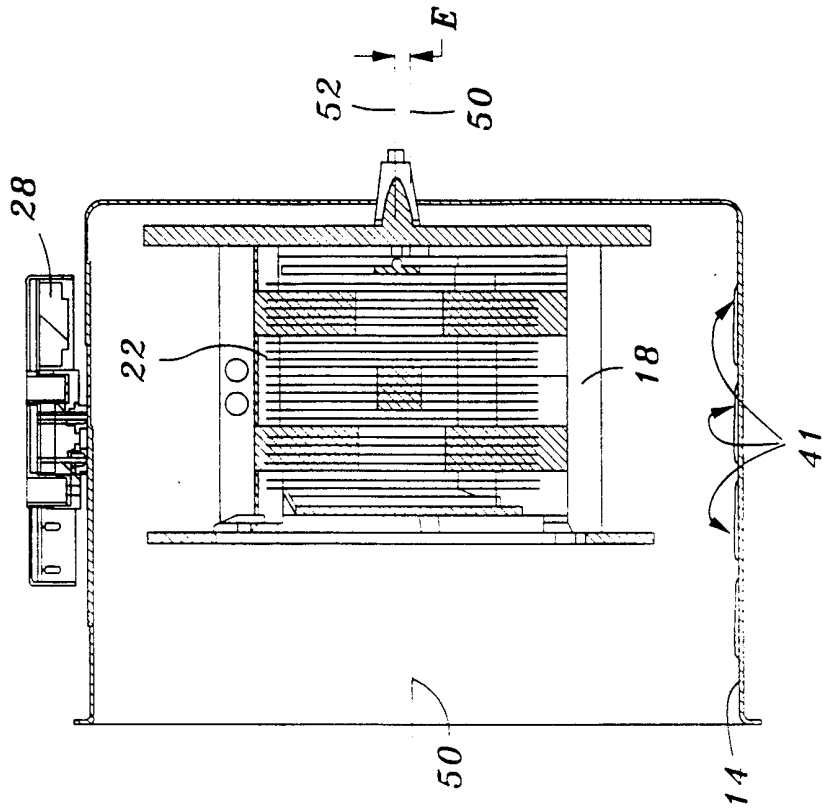
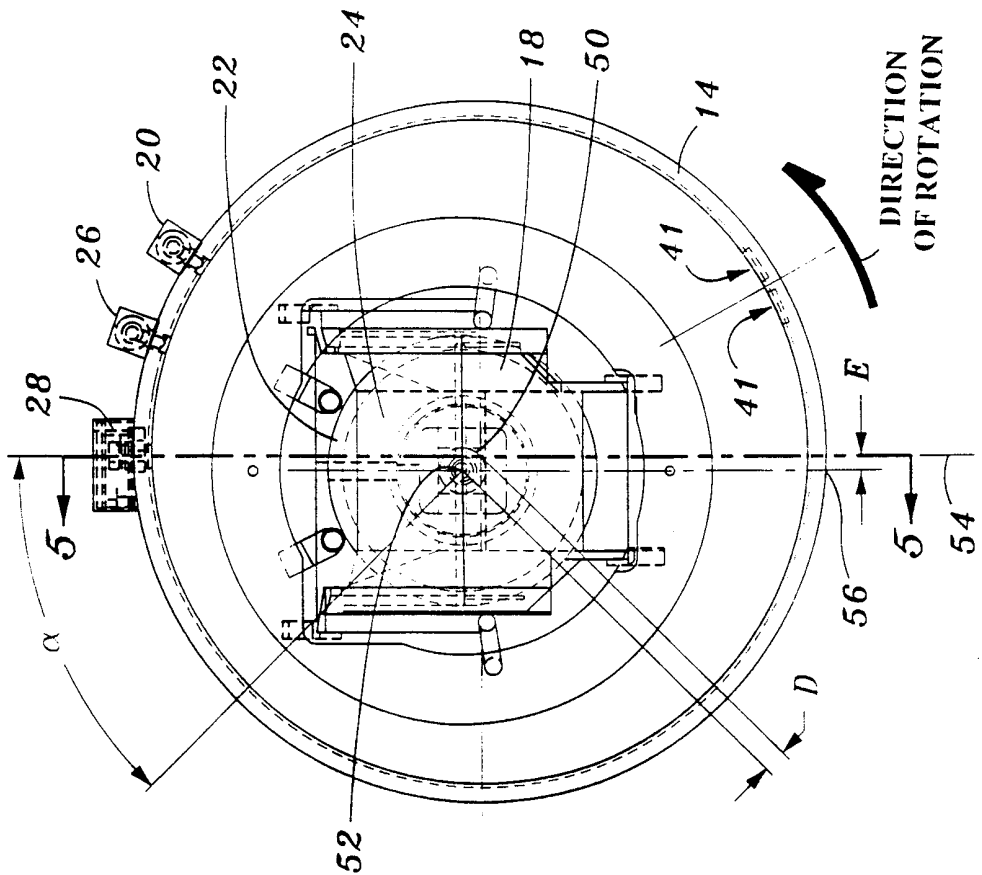


Fig. 4



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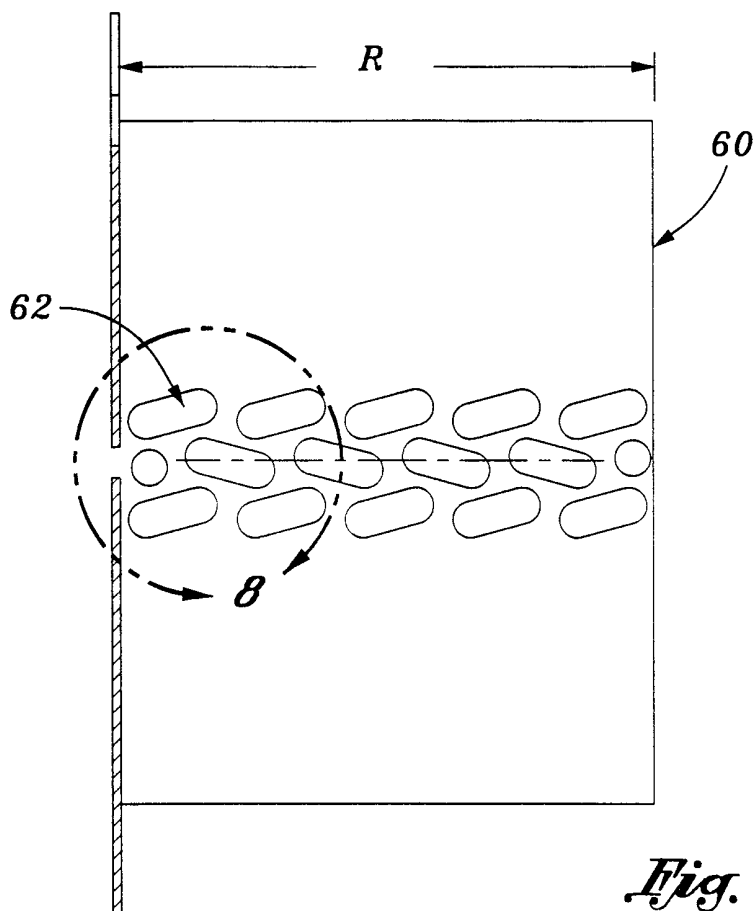


Fig. 7

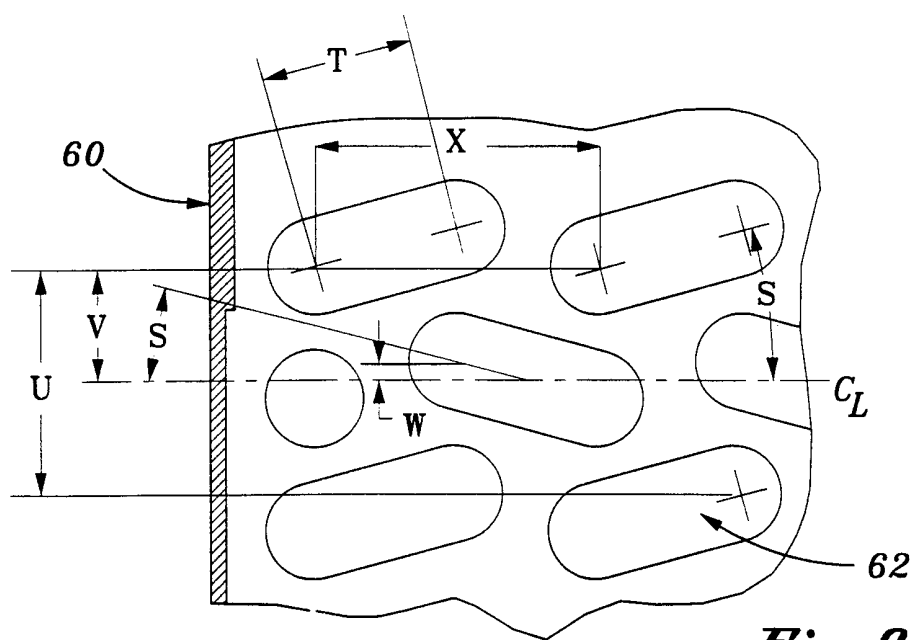


Fig. 8

Fig. 9

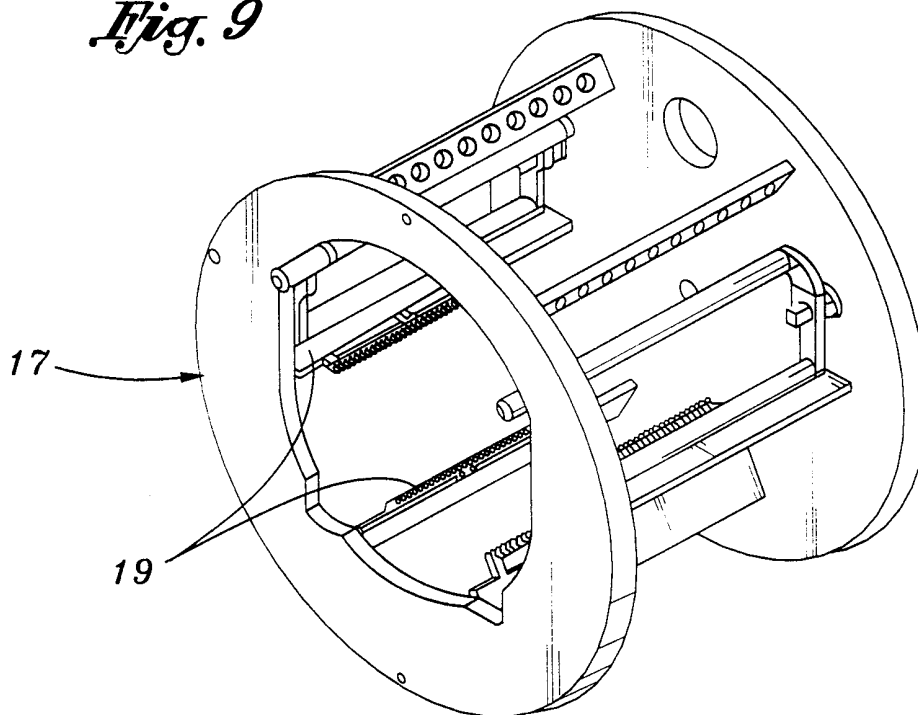
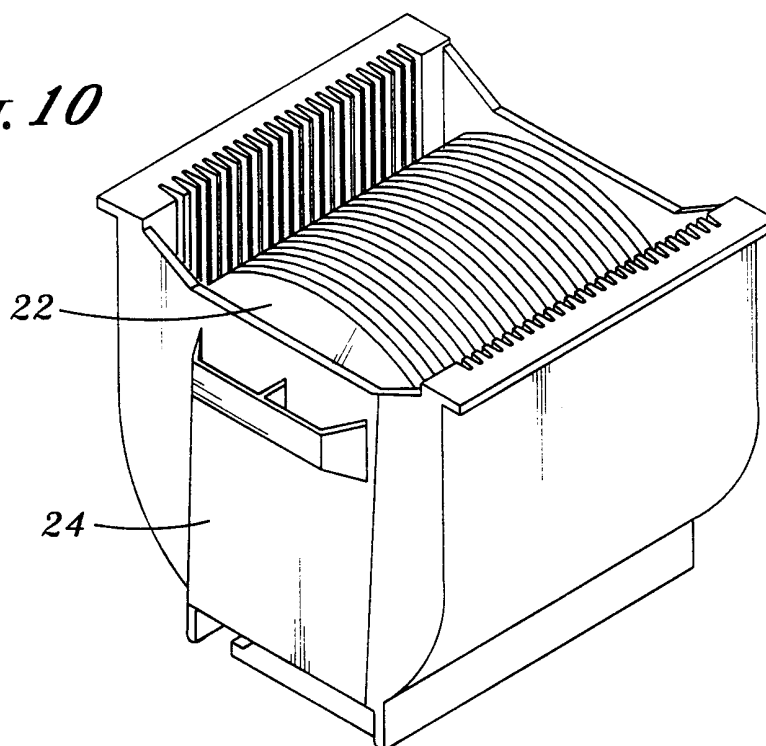


Fig. 10



INTERNATIONAL SEARCH REPORT

International application No.
PCT/US99/13984

A. CLASSIFICATION OF SUBJECT MATTER

IPC(6) :B08B 3/00; B01D 33/00

US CL :134/95.2, 902, 184, 186; 210/360.1, 364, 365, 367

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

U.S. : 134/95.2, 902, 184, 186
210/360.1, 364, 365, 367

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 2,669,660 A [GAMBRILL] 16 February 1954, see entire document.	1, 2, 6
X	US 4,153,551 A [HULTSCH et al.] 08 May 1979, see entire document.	1-13
Y	US 5,154,199 A [THOMPSON et al.] 13 October 1992, see entire document.	14-20
Y	US 4,571,850 A [HUNT et al.] 25 February 1986, see entire document.	14-20
A,P	US 5,784,797 A [CURTIS et al.] 28 July 1998, see entire document.	1-20
A	US 5,664,337 A [DAVIS et al.] 09 September 1997, see entire document.	1-20


 Further documents are listed in the continuation of Box C.
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Authorized officer

PAUL J. LEE 
Telephone No. (703)305-0661

INTERNATIONAL SEARCH REPORT

International application No.
PCT/US99/13984

C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US 5,232,328 A [OWCZARZ et al.] 03 August 1993, see entire document.	1-20
A	US 4,283,286 A [WILKESMANN] 11 August 1981, see entire document.	1-20